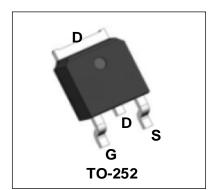


30V N-Channel Enhancement Mode Power MOSFET

Description

WMO55N03T1 uses advanced power trench technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

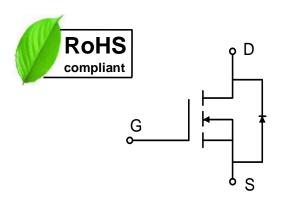


Features

- V_{DS} = 30V, I_{D} =55 A $R_{DS(on)}$ < 8.5m Ω @ V_{GS} = 10V $R_{DS(on)}$ < 12.5m Ω @ V_{GS} = 4.5V
- Green Device Available
- Low Gate Charge
- Advanced High Cell Density Trench Technology
- 100% EAS Guaranteed

Applications

- Power Management Switches
- Synchronous Buck Converter



Absolute Maximum Ratings

Parameter		Symbol	Value	Unit	
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	±20	V	
	T _C =25℃	· Ι _D	55		
Continuous Drain Current@10V1	T _C =100℃		40	Α	
	T _A =25°C		13.6		
	T _A =70°C		11.4		
Pulsed Drain Current ²		I _{DM}	110	А	
Single Pulse Avalanche Energy ³		EAS	57.8	mJ	
Avalanche Current		las	34	А	
Total Power Dissipation ⁴	T _C =25℃	P _D	41	- W	
	T _A =25°C		2.42		
Operating Junction and Storage Temperature Range		T _J , T _{STG}	-55 to+175	°C	

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ¹	R _{0JA}	62	°C/W
Thermal Resistance from Junction-to-Case ¹	Rejc	3.6	°C/W



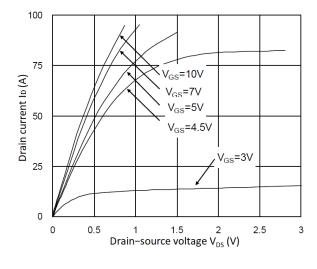
Electrical Characteristics T_c = 25°C, unless otherwise noted

Parameter		Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static Characteristics				•				
Drain-Source Breakdown Voltage		V _{(BR)DSS}	$V_{GS} = 0V, I_D = 250\mu A$	30	-	-	V	
Gate-body Leakage current		I _{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA	
Zero Gate Voltage Drain Current	T _J =25°C	IDSS	V _{DS} = 24V, V _{GS} = 0V	-	-	1	μА	
	T _J =55°C			-	-	5		
Gate-Threshold Voltage		V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.2	1.6	2.5	V	
Drain-Source On-Resistance ²			V _{GS} = 10V, I _D = 30A	-	7	8.5	- mΩ	
		R _{DS(on)}	V _{GS} = 4.5V, I _D = 15A	-	9.1	12.5		
Forward Trans conductance		G fs	V _{DS} = 5V, I _D = 30A	-	37	-	S	
Dynamic Characteristics	3					•		
Input Capacitance	put Capacitance C _{iss}			-	1107	-	pF	
Output Capacitance Reverse Transfer Capacitance		Coss	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1MHz	-	163	-		
		Crss]	-	115	-		
Switching Characteristic	s							
Gate Resistance		Rg	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	-	2.2	-	Ω	
Total Gate Charge		Qg		-	12.6	-	nC	
Gate-Source Charge		Q _{gs}	$V_{GS} = 4.5V, V_{DS} = 15V,$ $I_{D}=15A$	-	4.2	-		
Gate-Drain Charge		\mathbf{Q}_{gd}		-	5.1	-		
Turn-On Delay Time		t _{d(on)}		-	4.6	-	. nS	
Rise Time		tr	$V_{GS} = 10V, V_{DD} = 15V,$	-	12.2	-		
Turn-Off Delay Time Fall Time		t _{d(off)}	$R_G = 3.3\Omega, I_D = 15A$	-	26.6	-		
		t _f		-	8	-		
Drain-Source Body Diod	e Charact	eristics			•	•		
Diode Forward Voltage ²		V _{SD}	$I_S = 1A$, $V_{GS} = 0V$	-	-	1.0	V	
Continuous Source Current ^{1,5}		Vg = VD= 0V,Force Current	-	-	55	Α		
Body Diode Reverse Recovery Time		t _{rr}		-	9.2	-	nS	
Body Diode Reverse Recove Charge	ecovery Q_{rr} $I_F = 30A$, $dI/dt = 100A/\mu s$		-	2	-	nC		

Notes:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS} =34A
- 4.The power dissipation is limited by 175°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.





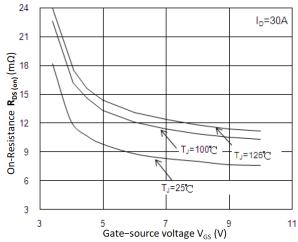


Figure 1. Output Characteristics

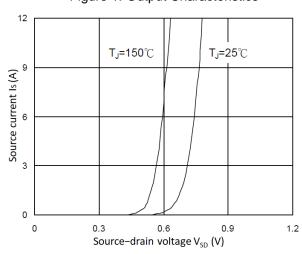


Figure 2. R_{DS}(on) vs. V_{GS}

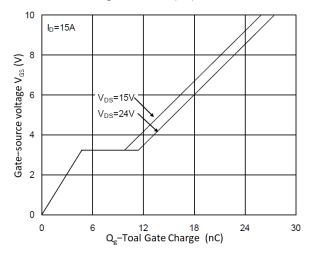


Figure 3. Forward Characteristics of Reverse

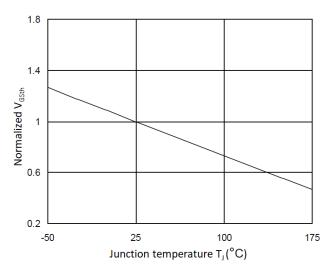


Figure 4. Gate Charge Characteristics

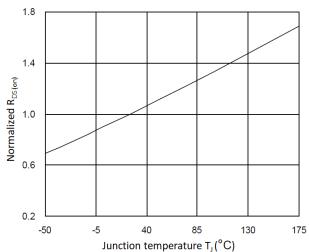


Figure 5. Normalized V_{GSth} vs. T_J

Figure 6. Normalized RDS(on) vs. TJ



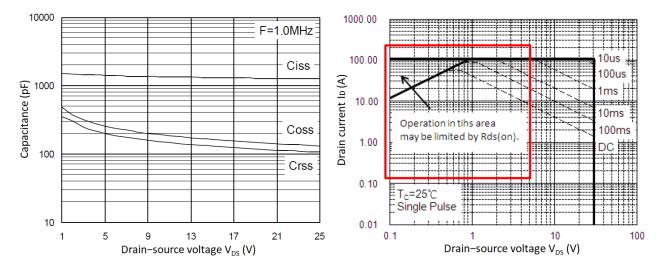


Figure 7. Capacitance Characteristics

Figure 8. Safe Operating Area

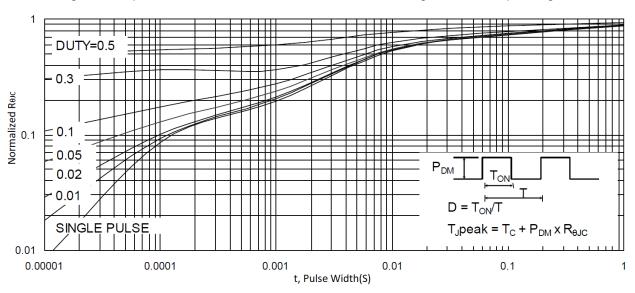


Figure 9. Normalized Maximum Transient Thermal Impedance

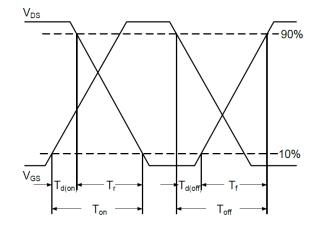


Figure 10. Switching Time Waveform

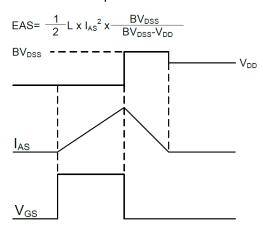
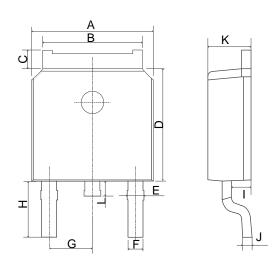


Figure 11. Unclamped Inductive Switching

Waveform



Mechanical Dimensions for TO-252



COMMON DIMENSIONS

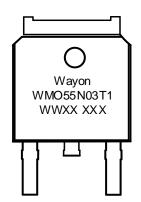
SYMBOL	MM			
	MIN	MAX		
А	6.40	6.80		
В	5.13	5.50		
С	0.88	1.28		
D	5.90	6.22		
Е	0.68	1.10		
F	0.68	0.91		
G	2.29REF			
Н	2.90REF			
I	0.85	1.17		
J	0.51REF			
К	2.10	2.50		
L	0.40	1.00		



Ordering Information

Part	Package	Marking	Packing method
WMO55N03T1	TO-252	WMO55N03T1	Tape and Reel

Marking Information



WMO55N03T1 = Device code WWXX XXX= Manufacturing code

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For additional information, please contact your local Sales Representative.

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